

General Description

The WST2315 is the highest performance trench P-ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WST2315 meet the RoHS and Green Product requirement, with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Green Device Available

Product Summery

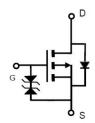
BVDSS	RDSON	ID
-20V	50mΩ	-4.4A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- ESD:3K

SOT-23-3L Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units	
V_{DS}	Drain-Source Voltage	-20	V	
V_{GS}	Gate-Source Voltage	±12	V	
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ -4.5V ¹	-4.4	Α	
I _D @T _C =70°C	Continuous Drain Current, V _{GS} @ -4.5V ¹	-2.8	Α	
I _{DM}	Pulsed Drain Current ²	-14	Α	
P _D @T _A =25°C	Total Power Dissipation ³	1	W	
T _{STG}	Storage Temperature Range -55 to 150		°C	
TJ	Operating Junction Temperature Range -55 to 150		°C	

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{0JA}	Thermal Resistance Junction-Ambient ¹		125	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case ¹		80	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-20			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV _{DSS} Temperature Coefficient	Reference to 25°C , I _D =-1mA		-0.014		V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =-4.5V , I _D =-3A		50	63	mΩ
		V _{GS} =-2.5V , I _D =-2A		60	74	
$V_{GS(th)}$	Gate Threshold Voltage	V _{GS} =V _{DS} . In =-250uA	-0.5	-0.8	-1.0	٧
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	V _{GS} =V _{DS} , I _D =-250uA		3.95		mV/℃
	Drain Source Leakage Current	V _{DS} =-16V , V _{GS} =0V , T _J =25℃			-1	uA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-16V , V _{GS} =0V , T _J =55℃			-5	
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm 12V$, V_{DS} = $0V$			±100	nA
gfs	Forward Transconductance	V_{DS} =-5V , I_D =-3A		16		S
Qg	Total Gate Charge (-4.5V)			10.2	14.3	
Q_{gs}	Gate-Source Charge	V _{DS} =-15V , V _{GS} =-4.5V , I _D =-3A		1.89	2.6	nC
Q_{gd}	Gate-Drain Charge			3.1	4.3	
$T_{d(on)}$	Turn-On Delay Time			5.6	11.2	
T _r	Rise Time	V _{DD} =-10V , V _{GS} =-4.5V ,		40.8	73	no
$T_{d(off)}$	Turn-Off Delay Time	$R_G=3.3\Omega$, $I_D=-3A$		33.6	67	ns
T _f	Fall Time			18	36	
C _{iss}	Input Capacitance			416		
Coss	Output Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		114		pF
C _{rss}	Reverse Transfer Capacitance			55		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,4}	// =// =0)/ Force Current			-4.3	Α
I _{SM}	Pulsed Source Current ^{2,4}	V _G =V _D =0V , Force Current			-14	Α
V_{SD}	Diode Forward Voltage ²	V_{GS} =0V , I_{S} =-1A , T_{J} =25 $^{\circ}$ C			-1	V
t _{rr}	Reverse Recovery Time			21.8		nS
Q _{rr}	Reverse Recovery Charge	lF=-3A , dl/dt=100A/μs , T _J =25℃		6.9		nC

Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, t<10 sec.
- 2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%
- 4. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

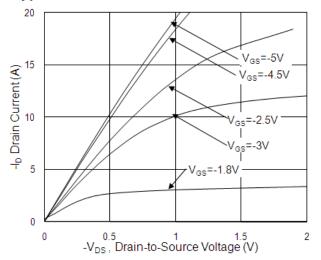


Fig.1 Typical Output Characteristics

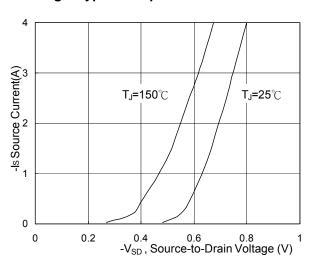


Fig.3 Forward Characteristics of Reverse

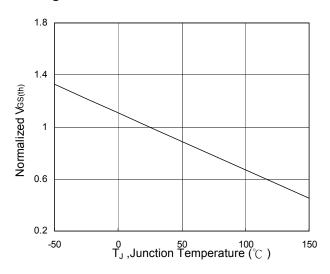


Fig.5 Normalized V_{GS(th)} vs. T_J

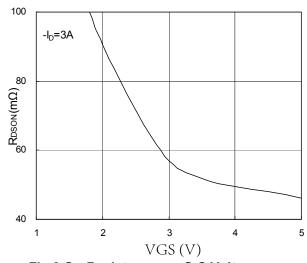


Fig.2 On-Resistance vs. G-S Voltage

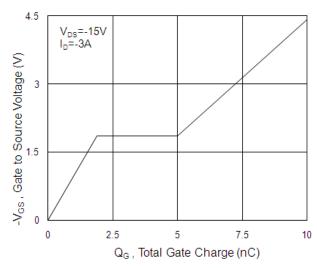


Fig.4 Gate-charge Characteristics

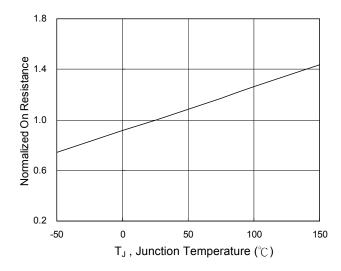
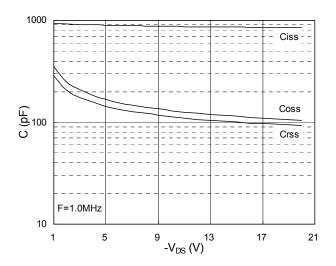


Fig.6 Normalized R_{DSON} vs. T_J





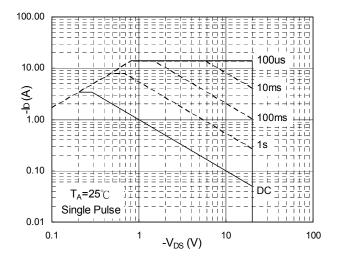


Fig.7 Capacitance

Fig.8 Safe Operating Area

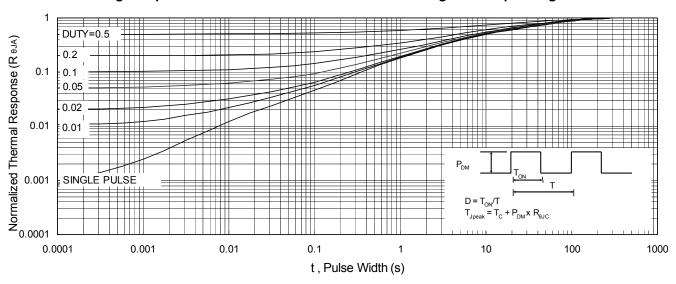
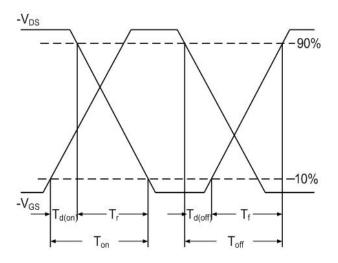


Fig.9 Normalized Maximum Transient Thermal Impedance



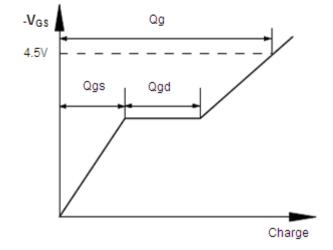


Fig.10 Switching Time Waveform

Fig.11 Gate Charge Waveform



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